Vertical-Chips · Glass Package 垂直芯片 · 玻璃封装 Multi-Color LEDs 多色光源

Main Applications:

主要应用领域:

- ✓ directional projection and beam lighting with small angle for projection, light beam, dyeing, pattern, audience, business, hotel, museum, etc. 小角度方向性投射类照明,适用于投射,光束,染色,图案,观众,商业,酒店,博物馆等
- ✓ intelligent color-mixing lighting 智能混色照明
- ✓ over broader CCT range with higher Ra for lighting of high-end business, stage, studio, photography etc.
 宽色温范围高显指照明,适用于高端商业、舞台、影视、摄影等
- ✓ medical and micro-instrument lighting 医疗与显微器械照明



Main Parameters	Typical Values
Voltage (V)	R 2 B 3 G 3 W 3
Current (mA)	R 1175 B 1175 G 1175 W 1175
Max. Power (W) Note	16.5 in total
LES (mm)	2.2x2.3
CCT (K) / Ra	6000-7000
Color / Dominant Wavelength (nm)	R / 617.5-627.5 G / 520-530 B / 450-460
Matched Cu Board	H016-1818 H055-2833 H035-3037(P8) H042-2837(P5)

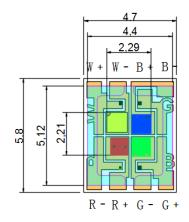
Main Features

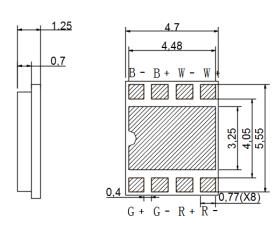
Low Power Four Color Integrated Lighting Source;

Glass Package Using AIN Ceramic Substrate for Low Heat Resistance;

Natural Chip Emitting Colors, High Color Purity and Consistency;

Other Power, LES, Color Combination, CCT and Ra Available on Request;







Main Parameters	Typical Values
Voltage (V)	R 2 B 3 G 3 W 3
Current (mA)	R 1850 B 1850 G 1850 W 1850
Max. Power (W) Note	26.2 in total
LES (mm)	2.2x2.5
CCT (K) /Ra	6000-7000
Color / Dominant Wavelength (nm)	R / 617.5-627.5 G / 520-530 B / 450-460
Matched Cu Board	H016-1818 H055-2833 H035-3037(P8) H042-2837(P5)

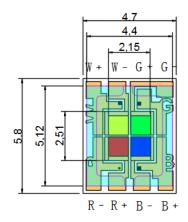
Main Features

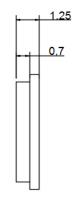
Low Power Four Color Integrated Lighting Source;

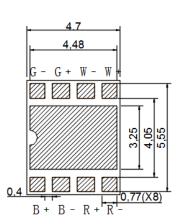
Glass Package Using AIN Ceramic Substrate for Low Heat Resistance;

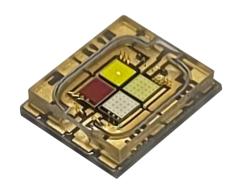
Natural Chip Emitting Colors, High Color Purity and Consistency;

Other Power, LES, Color Combination, CCT and Ra Available on Request;









Main Parameters	Typical Values
Voltage (V)	R 2 B 3 G 3 PC-L 3
Current (mA)	R 1850 B 1850 G 1850 PC-L 1450
Max. Power (W) Note	24.6 in total
LES (mm)	2.2x2.3
CCT (K) / Ra	PC-L / 4150-4400
Color / Dominant Wavelength (nm)	R / 617.5-627.5 G / 520-530 B / 450-460
Matched Cu Board	H016-1818 H055-2833 H035-3037(P8) H042-2837(P5)

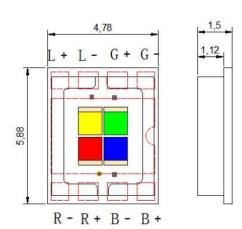
Main Features

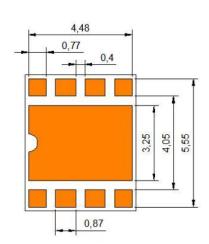
Low Power Four Color Integrated Lighting Source;

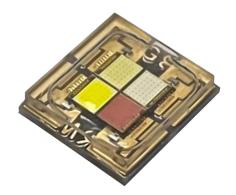
Glass Package Using AIN Ceramic Substrate for Low Heat Resistance;

Natural Chip Emitting Colors, High Color Purity and Consistency;

Other Power, LES, Color Combination, CCT and Ra Available on Request;







Main Parameters	Typical Values
Voltage (V)	R 2 B 3 G 3 W 3
Current (mA)	R 3575 B 3575 G 3575 W 3575
Max. Power (W) Note	49.9 in total
LES (mm)	3.0x3.3
CCT (K) / Ra	6000-7000
Color / Dominant Wavelength (nm)	R / 617.5-627.5 G / 520-530 B / 450-460
Matched Cu Board	H017-1818 H046-3737

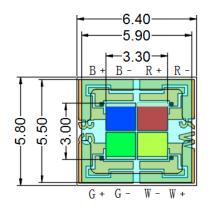
Main Features

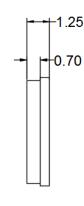
Middle Power Four Color Integrated Lighting Source;

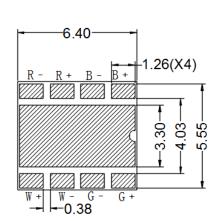
Glass Package Using AIN Ceramic Substrate for Low Heat Resistance;

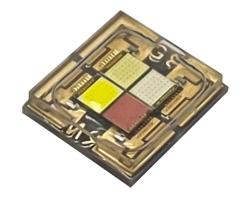
Natural Chip Emitting Colors, High Color Purity and Consistency;

Other Power, LES, Color Combination, CCT and Ra Available on Request;









Main Parameters	Typical Values
Voltage (V)	R 2 G 3 B 3 PC-L 3
Current (mA)	R 3575 G 3575 B 3575 PC-L 2775
Max. Power (W) Note	46.8 in total
LES (mm)	3.0x3.3
CCT (K) / Ra	PC-L / 4150-4400
Color / Dominant Wavelength (nm)	R / 617.5-627.5 G / 520-530 B / 450-460
Matched Cu Board	H017-1818 H046-3737

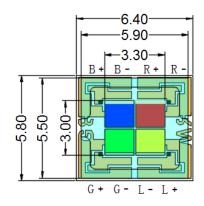
Main Features

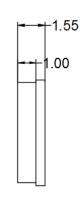
Middle Power Four Color Integrated Lighting Source;

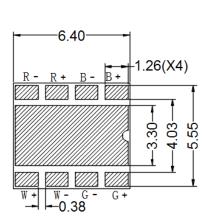
Glass Package Using AIN Ceramic Substrate for Low Heat Resistance;

Natural Chip Emitting Colors, High Color Purity and Consistency;

Other Power, LES, Color Combination, CCT and Ra Available on Request;









Main Parameters	Typical Values
Voltage (V)	R 2 G 3 B 3 C 3 PC-A 3 PC-L 3
Current (mA)	R 1850 G 1850 B 1850 C 1850 PC-A 1100 PC-L 1100
Max. Power (W) Note	34.6 in total
LES (mm)	4.2
CCT (K) / Ra	PC-A / 1600-1800 PC-L / 4150-4400
Color / Dominant Wavelength (nm)	R / 617.5-627.5 G / 520-530 B / 450-460 C / 485-495
Matched Cu Board	

Main Features

Low Power Six Color Integrated Lighting Source;

Glass Package Using AIN Ceramic Substrate for Low Heat Resistance;

Natural Chip Emitting Colors, High Color Purity and Consistency;

Other Power, LES, Color Combination, CCT and Ra Available on Request;

